

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT2907374

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
YANG WEI	06/17/2014
HAO-MING WEI	06/17/2014
KAI-LI JIANG	06/17/2014
SHOU-SHAN FAN	06/17/2014
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State/Country:	CHINA
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State/Country:	TAIWAN
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14310301
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DATE SIGNED:	06/20/2014
Total Attachments: 2	

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ASSIGNMENT

In consideration of value received, the receipt and sufficiency of which are hereby acknowledged, the undersigned ASSIGNOR(S)

- 1. YANG WEI , residing at Beijing, China
- 2. HAO-MING WEI , residing at Beijing, China
- 3. KAI-LI JIANG , residing at Beijing, China
- 4. SHOU-SHAN FAN , residing at Beijing, China
- 5. _____ , residing at _____
- 6. _____ , residing at _____
- 7. _____ , residing at _____
- 8. _____ , residing at _____

hereby sell(s), assign(s) and transfer(s) unto: **TSINGHUA UNIVERSITY** having a principal place of business at **No.1, Qinghua Yuan, Haidian District, Beijing City, P.R.C.** and **HON HAI PRECISION INDUSTRY CO., LTD.** having a principal place of business at **66, Chung Shan Road, Tu-Cheng Dist., New Taipei City, Taiwan, R.O.C.** hereafter designated "ASSIGNEE" the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100, in the invention and all patent applications including any and all divisions, continuations, substitutes, and reissues thereof, and all resulting patents, known as **METHOD FOR TRANSFERRING CARBON NANOTUBE ARRAY AND METHOD FOR FORMING CARBON NANOTUBE STRUCTURE** for which the undersigned

previously executed --- Ser. No. _____ and filing date of _____
 is executing concurrently herewith

an application for Letters Patent of United States of America

AND the undersigned hereby authorize(s) and request(s) the United States Commissioner of Patents and Trademarks to issue said Letters Patent to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree(s) that the attorneys of record in said application, if any, shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree(s) to testify and execute any papers for ASSIGNEE, its successors, assigns and legal representatives, deemed essential by ASSIGNEE to ASSIGNEE's full protection and title in and to the invention hereby transferred.

1.	<u>Yang Wei</u> YANG WEI	<u>Jun. 17, 2014</u> Date
2.	<u>HAOMING WEI</u> HAO-MING WEI	<u>Jun. 17, 2014</u> Date
3.	<u>(Kali)</u> KALIJIANG	<u>Jun. 17, 2014</u> Date
4.	<u>Shou Shan Fan</u> SHOU-SHAN FAN	<u>Jun. 17, 2014</u> Date
5.	_____	_____ Date
6.	_____	_____ Date
7.	_____	_____ Date
8.	_____	_____ Date
9.	_____	_____ Date